Water-based, pH-neutral defluxing agent for spray-in-air cleaning processes



VIGON® N 600 is an innovative defluxing product with a revolutionary pH-neutral formulation. The cleaning agent was developed to be used in sprayin-air inline and batch cleaning applications. Its excellent cleaning performance and ability to remove a wide range of flux residues from electronic assemblies under pH-neutral conditions is unprecedented. Due to its neutral pH-value, the cleaning agent also demonstrates a high level of

material compatibility with sensitive metals and polymers.

Areas of application: PCB cleaning		Additional product information for this :
Low solid flux residues*	+	
Water-soluble flux residues*	++	Technical Information 3: Material Compatibility overview
Rosin-based flux residues*	++	MPC® Technology Sheet: Detailed information on the MPC® Technology
Solder paste (unsoldered)	+	

⁺⁺ highly recommended, best results

- + recommended
- 0 possible
- (tested for standard batch cleaning equipment)
- not recommended* Valid for all standard-, lead-free and lead-based solders

Technical Centers - ① America, ② Europe, ③ Malaysia, ④ East-China, ⑤ South-China Cleaning Process Solutions under Production Floor Conditions











Contact ZESTRON's Process Engineering Team for free-of-charge cleaning trials: Phone: +49-841-635-26; Email: techsupport@zestron.com

Advantages compared to other cleaners:

- Due to its neutral pH-value, VIGON® N 600 demonstrates an unprecedented level of material compatibility on sensitive materials such as aluminum, brass or nickel, plastics, labels and inks.
- Performs well at low application concentrations in specific processes
- Good results underneath low standoff components
- Due to the neutrality of the cleaning agent, the permission for sewage disposal is easier to obtain.

Please refer to the material compatibility list (Technical Information 3) before cleaning plastics.

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merica South Asia

Process Steps	1. Cleaning	2. Rinsing	3. Drying
Spray-in-air (inline & batch)	VIGON® N 600	warm DI-water ¹	Hot air or circulating air
Dip tank (with vacuum drying)	VIGON® N 600	warm DI-water ¹	Hot air with vacuum drying

¹ the DI-water should have a temperature of 30-40°C.

Technical Data Please note that the following information represents VIGON® N 600 at 15 % concentration.					
Density	(g/ccm) at 20°C/68°F	1.00			
Surface tension	(mN/m) at 25°C/77°F	27.1			
Boiling point	°C/°F	98 - 229°C / 208 - 444°F			
Flash point	°C/°F	None until boiling			
pH-value	10g/l H ₂ O	7.5 ²			
Vapor pressure	(mbar) at 20°C/68°F	Approx. 20			
Cleaning temperature	°C/°F	40 - 70°C / 104 - 158°F			
Solubility in water		Soluble			
Application concentration ¹ (inline)	Concentrate	10 -15 %			
Application concentration ¹ (batch)	Concentrate	15 - 20%			
HMIS Rating	Health-Flammability-Reactivity	0 - 0 - 0			

¹ VIGON® N 600 is recommended to be diluted in DI-water. ² +/-0.5

100% compliance with EU

guidelines (RoHS 1 & 2, WEEE)

PRODUCT FEATURES



Extensively tested and suitable for cleaning of lead-free solder pastes



MPC® Technology ensures an extremely long bath life when used in a closed loop system



Product is free of any critical substances according to SIN & SVHC lists

Filter recommendation

- To take full advantage of the MPC® Technology and further expand the bath life of VIGON® N 600, filtration is recommended.
- For details, please request our "Filter Recommendation" sheet.

Environmental, health and safety regulations:

- VIGON® N 600 is water-based and biodegradable.
- VIGON® N 600 is formulated free of any halogenated compounds.
- Refer to the MSDS for specific handling precautions and instructions.

Availability/Storage:

- VIGON® N 600 is available as a concentrate in 11 bottles, 51 or 251 containers and 2001 drums.
- Store VIGON® N 600 in the original container at a temperature between 5 - 30°C / 41 - 86°F.
- The product has a minimum shelf life of 5 years in factory sealed containers.

Cleaning Standards

Electronic assemblies cleaned with $VIGON^{\$}$ N 600 in a ZESTRON specified process meet the following industry standards:

- IPC-A-610 Visual cleanliness
- J-STD 001 Ionic and resin cleanliness
- IPC-TM 650 and DIN 32513 (surface resistance)
- J-STD 003 Solderability

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